

φ0.2 Drilling Performance for FC-BGA

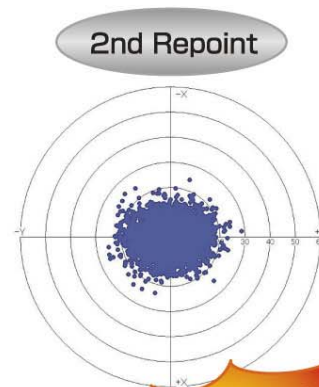
Flip Chip-BGA用加工事例 (φ0.2)

加工条件 [Drilling Condition]

Work Material : MCL-E-679FG (R) (12/12μm Cu)
 t0.8(double-sided) x 3stacks
 Set Life: 4,000hits



穴位置精度 [Hole Registration Accuracy]



内壁粗さ [Hole Wall Quality After 4000hits]

